# SPECIFICATION FOR APPROVAL

CUSTOMER	:	
PRODUCT TYPE	:	SMD GLASS SEALING XTAL 3.2 × 2.5
NOMINAL FREQ.	:	38.40000MHz
TXC P/N	:	7V38400002
REVISION		S1
CUSTOMER P/N	:	
PM / SALES		
DATE	:	
CUSTOMER SIGNA	ATUF	RE & Date
	_	

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

MSL:Level 1
RoHS Compliant

Pb used in sealing glass material is exempt from EU directive

www.txccorp.com

# PRODUCT SPECIFICATION SHEET

PRODUCT TYPE : SMD GLASS SEALING XTAL 3.2 × 2.5

NOMINAL FREQ. : 38.400000MHz

TXC P/N : 7V38400002

REVISION : S1

PE/RD	QA	MFG
Lobin Huang Robin Huang		
21-Nov-16		

# NOTE:

(1)The green product standard set by TXC is based upon the international standards. Related information is publicly described on the TXC's Website, and updated regularly. The document is compliant with the latest green product quality system directives at the time.

(2) Revision "Sx" is for engineering samples only. PE/RD's approval required.

(3) Revision "Ax" is production ready. PE, QA and MFG's approval required

MSL:Level 1
RoHS Compliant

Pb used in sealing glass material is exempt from EU directive



<u>Rev</u>	Revise page	Revise contents	<u>Date</u>	Ref.No.	Reviser
S1	N/A	Initial released	21-Nov-16	N/A	Xiaoyan Jiang

TXC P/N: 7V38400002 REVIS

REVISION:

S1

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# **Spec Sheet Contents**

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#### **■ ELECTRICAL SPECIFICATIONS**

# Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature :  $25\pm5^{\circ}$ C Relative humidity :  $40\%\sim70\%$ 

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature :  $25\pm3^{\circ}$ C Relative humidity :  $40\%\sim70\%$ 

# Measure equipment

Electrical characteristics measured by S&A250B or equivalent.

# Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

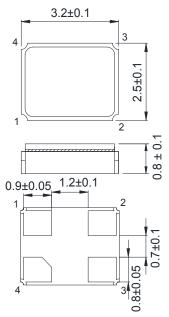
# **Unit Weight:**

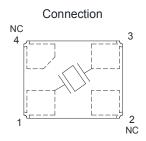
0.018±0.001 g/pcs

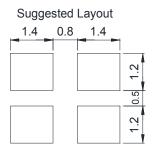
	Parameters	SYM.		Electric	al Spec.		Notes
	Parameters	STIVI.	MIN	TYP	MAX	UNITS	Notes
1	Nominal Frequency	FL	3	88.40000	0	MHz	-
2	Oscillation Mode	-	Fı	ındamen	tal	-	-
3	Load Capacitance	CL		12		pF	-
4	Frequency Tolerance	-	- ±20 p		ppm	at 25 ± 3 ℃	
5	Frequency Stability	-	±20		ppm	Over Operating Temp. Range (Reference 25°ℂ)	
6	Operating Temperature	-	-40	~	85	$^{\circ}\!\mathbb{C}$	-
7	Aging	-		±3		ppm	1st Year
8	Drive Level	DL	-	100	300	uW	-
9	Equivalent Resistance Rr	Rr	-	-	40	Ω	-
10	Shunt Capacitance C0	C0	-	-	3	pF	-
11	Insulation Resistance	-	500	-	-	МΩ	at DC 100V
12	Storage Temperature Range	-	-40	~	85	$^{\circ}\!\mathbb{C}$	-

# DIMENSIONS

(Unit:mm)

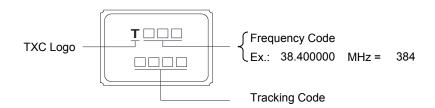






\*Coplanarity of solderable areas Camber 0.10 mm Max

#### MARKING

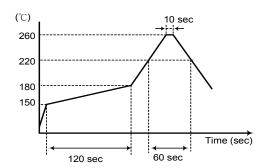


0.25

Production Location: China(Ningbo), China(Chungking).

# **■ SUGGESTED REFLOW PROFILE**

Solder melting point :220±10  $^{\circ}\!\!$  C , 60 sec. Min. Peak Temperature: 260 ± 5  $^{\circ}\!\!$  C , 10 sec. Max.



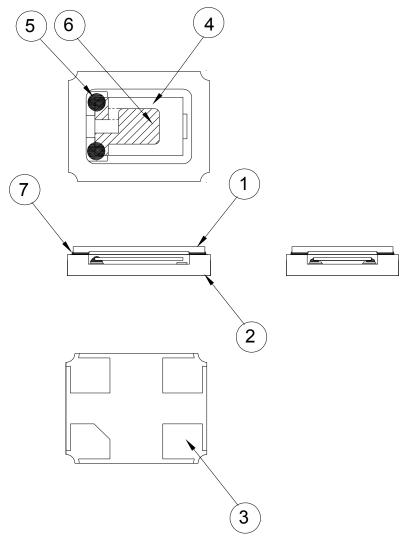
# ■ SUGGESTED MANUAL SOLDER CONDITION

Temperature: 350 ± 10  $^{\circ}$ C

Time: 3 sec.

Re-solder times: twice

# ■ STRUCTURE ILLUSTRATION



NO	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Сар	Ceramic (Al <sub>2</sub> O <sub>3</sub> )	-
2	Package	Ceramic (Al <sub>2</sub> O <sub>3</sub> )	-
3	PAD	Au	Tungsten metalize
			+ Ni plating
			+ Au plating
4	Crystal blank	SiO <sub>2</sub>	-
5	Conductive adhesive	Resin+Ag	-
6	Electrode	Ag	-
7	Sealing Glass	Glass(PbO)	-

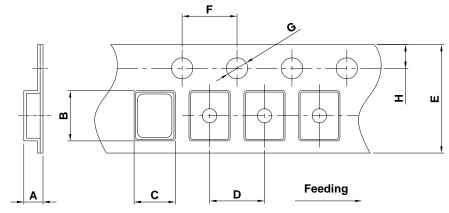
TXC P/N: 7V38400002

**REVISION:** 

S1

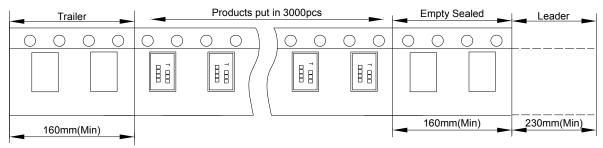
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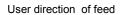
# **■ EMBOSS CARRIER TAPE & REEL**

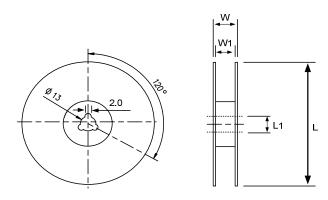


DIMENSIONS	Α	В	С	D	E	F	G	Н	
DIMENSIONS	1.65±0.10	3.40±0.10	2.70±0.10	4.00±0.10	8.00±0.20	4.00±0.10	1.55±0.10	1.75±0.10	(UNIT: mm)

# REMARK:



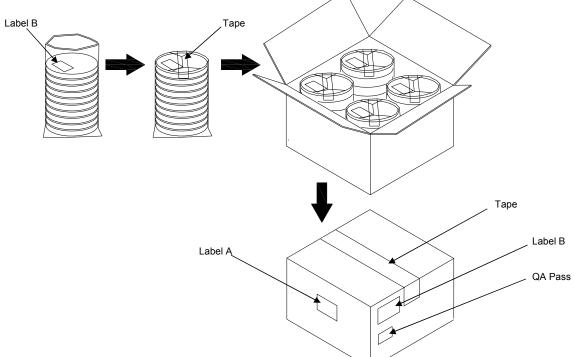




DIMENSIONS	L	L1	W	W1	
DIVILIVOIONO	178±1.00	13±0.50	11.5±0.20	8±0.10	(UNIT: mm)



#### **■ PACKING**



(Label A) Size:100 X 100mm

# $\mathsf{TXC}$

Inv No: 00096815

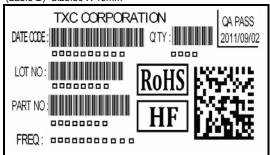
Po No: 21106326- 24- 1

Part No:

Q'ty: 40000 PCS

C/No: 157- 44

(Lable B) Size:80 X 40mm



### [STORAGE]

- 1.Don't be caught in the rain.
- 2.The storage environment shall be  $5^{\circ}$ C  $\sim$ 40 $^{\circ}$ C temperature and 30%  $\sim$  75%RH humidity and free from the sun shine.
- 3.If customers have special requirements, we can paste labels according to it.

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# **■ RELIABILITY SPECIFICATIONS**

# 1.Mechanical Endurance

No.	Test Item	Test Mo	ethods	Test Criteria
1.1	Drop Test	150 cm height,3 times on concrete floo	A . C	
1.2	Mechanical Shock	Device are shocked to half sine wave (perpendicular axes each 3 times. 0.5 n	A . C	
1.3	Vibration	Frequency range Amplitude Sweep time Perpendicular axes each test time	A.C	
1.4	Solderability	Temperature Immersing depth Immersion time Flux	245 °C ± 5°C 0.5 mm minimum 5 ± 1 seconds Rosin resin methyl alcohol solvent (1:4)	E

# 2. Environmental Endurance

No.	Test Item	Test Methods	Test Criteria
2.1	Resistance To Soldering Heat	Pre-heat temperature $125 ^{\circ}\text{C}$ Pre-heat time $60 ^{\circ}$ 120 sec.Test temperature $260 \pm 5 ^{\circ}\text{C}$ Test time $10 \pm 1 \text{sec.}$	B.C.D
2.2	High Temp. Storage	+ 125 °C ± 3 °C for 500 ± 12 Hrs	B.C.D
2.3	Low Temp. Storage	- 40 °C ± 3 °C for 500 ± 12 Hrs	B . C . D
2.4	Temperature cycle	Total 100 cycles of the following temperature cycle $125 \pm 3^{\circ}\text{C}$ $25^{\circ}\text{C}$ $-40 \pm 3^{\circ}\text{C}$ $10 \text{ min.}$ $10 \text{ min.}$ $2 \text{ min. max.}$	B.C.D
2.5	High Temp&Humidity	85°C ± 3°C , RH 85% , 500 Hrs	B . C . D

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# **RELIABILITY SPECIFICATIONS**

	Specifications
А	Frequency change: Within ±5ppm or in customer's specification.
В	Frequency change: Within ±10ppm or in customer's specification.
С	Equivalent series resistance(E.S.R) change: Within $\pm 15\%$ or $10\Omega$ (larger value).
D	After conditioning , quartz crystal units shall be subjected to standard atmospheric conditions for 2 hour, and measured.
E	Minimum 95% of immersed terminal shall be covered with new uniform solder.

# **Measurement condition**

Electrical characteristics measured by S&A250B or equivalent.